

Description

The present invention generally relates to the field of electronic sensors, switches, or transducers. In particular, the present invention relates to a sensor using a capacitive measuring principle, a so-called capacitive sensor comprising capacitance sensing means and oscillator means, for measuring capacitive changes.

Electronic sensors of the prior art are commonly implemented in electric control circuits or electric regulator circuits. Unlike mechanically manipulated electric sensors, they are realized in a non-contacting way. This is especially true for so-called capacitive proximity switches which nowadays work without exception in a contactless manner. Such capacitive proximity switches are used for detecting how close an object the corresponding capacitive proximity switch is sensitive for has approached this capacitive proximity switch. If such an object has reached a certain predetermined distance from the electronic sensor the capacitive proximity switch is activated by means indicating the presence of the object. In the case of an electronic sensor being implemented as a make contact, the non-conductive electronic switch now becomes conductive, in the case of an electronic sensor being implemented as a break contact, the conductive electronic switch now becomes nonconducting. Electronic sensors of this well-known type are also used to detect whether a physical quantity of a medium the electronic sensor is sensitive for has reached a corresponding predetermined value.

Thus, the means indicating the presence of the object to be detected is an essential part of electronic switching devices such as described above. Such a means indicating the presence of the object is for example realized by an oscillator circuit which is capacitively or inductively controlled. Alternatively, a so-called optoelectronic proximity switch, for instance a photo resistor, a photo diode or a photo transistor can be used to detect the presence of the object.

Conventional capacitive proximity switches are implemented in such a manner that a sensing capacitance is connected in series to an oscillator circuit. The operation of this oscillator circuit can be described by the product $f \cdot A$ where f is the feedback factor and A the amplification factor. As long as a certain object approaching a conductive sensing plate has not sufficiently increased the capacitance of the capacitive proximity switch, the relation $f \cdot A < 1$ is valid for the oscillator circuit, i. e. the distance of the object from the capacitive proximity switch is still too large so as to trigger an oscillation. With the object reaching a predetermined distance from the capacitive proximity switch the growing capacitance between the object and the conductive sensing plate results in an augmentation of the feedback factor f (with the amplification factor A being constant). With the sensing capacitance being charged beyond a corresponding threshold and, consequently, the product $f \cdot A$ reaching the value 1, the oscillator circuit starts operating on the edge of the oscillation. The amplitude level of the oscillation is detected and used as an ON / OFF signal.

In general, the exactness and reliability of electronic sensors according to the prior art have left much to be desired. That is the reason why the detection of a well-defined threshold distance has turned out to be nearly impossible. Therefore, the secure detection of an approaching object has been very difficult and extremely deficient.

In consideration of the problems described above, it is an object of the present invention to provide a capacitive sensor capable of detecting the frequency shift by an oscillator principle different from the prior art so as to guarantee a reliable detection of an approaching object. This object implies that the present invention provides a capacitive sensor capable of precisely and continuously reproducing the threshold condition for the detection.

This object is achieved in that the oscillator means comprises a unity gain buffer for buffering the voltage over the capacitance sensing means without imposing any load on the latter, the output terminal of the unity gain buffer being connected to the input terminal of charging means for charging and discharging the capacitance sensing means via a resistor which is connected to the capacitance sensing means and to the output of the charging means.

In a preferred embodiment of the present invention, the capacitance sensing means comprises at least one conductive sensing plate arranged to detect the presence of an object placed at a variable distance. Of course, the capacitance sensing means can also be used to sense capacitive changes in many other applications as for example capacitive relative humidity sensors or capacitive membrane cells for pressure measurements.

Since the electrostatic field spreads out in all directions from the capacitance sensing means, the capacitance sensing means would be sensitive to all directions. Thus, guard means advantageously arranged to at least partially surround the capacitance sensing means is provided to shield the capacitance sensing means from capacitive changes caused by interferential action. Consequently, sensitivity just in the desired direction is warranted, and all capacitive changes due to electromagnetic interference as for instance electrostatic distortion affect only this guard means.

The capacitance sensing means is preferably connected to the input of the unity gain buffer. According to a particularly inventive embodiment of the present invention, this connection between the capacitance sensing means and the input of the unity gain buffer can be provided by a line on a printed circuit board. In an especially advantageous embodiment, the guard means is arranged as at least one line on at least one side and / or on the opposite side of the printed circuit board or in an inner layer of a multilayer printed circuit board.

The connection between the capacitance sensing means and the input of the unity gain buffer can also be provided by a shielded cable, which is advantageously tightly connected to the guard means in order to guarantee a shielding of the sensitive parts of the device without a gap. This shielded cable is preferably attached to the central portion of the guard means.

According to another embodiment of the present invention, the guard means is connected to the output of the unity gain buffer. Since the guard means preferably carries the same potential as the capacitance sensing means, the guard means does not have any capacitive influence on the capacitance sensing means. Generally, the guard means present an effective way of reducing the sensitivity of the capacitance sensing means with respect to the influence from electronics and molding material inside the capacitive sensor.

An ESD (electro static discharge) transient appears when large static charges are induced on the outside of the housing of the capacitive sensor for example by plastic granulates passing the head of the capacitive sensor and / or rubbing the housing of the capacitive sensor. With these large static charges discharging to the capacitance sensing means, the resulting ESD transient would destroy the sensitive input of the unity gain buffer of the oscillator means. Therefore, a protective means is placed between the capacitance sensing means and the guard means in order to avoid the negative effects of the ESD transient.

According to a particularly advantageous embodiment of the present invention, this protective means comprises a pair of diodes preferably directed in opposite ways. Since a common diode has a series capacitance of for instance about $5 \cdot 10^{-12}$ Farad, its capacitive load would be far too big to permit the detection of capacitive changes in the range below 10^{-12} Farad. But with the potential on both sides of the diodes being the same, no potential is left across the protective means and, consequently, no current flows through the diodes under normal operation. In case, that an ESD transient is imposed on the capacitance sensing means, one of the diodes (depending on the polarity of the ESD transient) becomes conductive and leads the transient energy to the guard means. From the guard means, the transient energy is led to ground or to an additional terminal on a certain potential in any preferred way because capacitive load on the output of the unity gain buffer has no effect on the capacitance sensing means.

Under normal operating conditions, the guard means always carries the same potential as the capacitance sensing means. This means that under normal operating conditions none of the diodes will ever be conductive and therefore the equivalent circuit for them would be a very small, negligible leakage current. The capacitive influence of such protective means between the capacitance sensing means and the guard means is then cancelled out and no capacitive load is imposed on the capacitance sensing means. Thus, such protective means can be used as a protection against electromagnetic interference as for instance electrostatic distortion.

According to a further embodiment of the present invention, the input terminal of the unity gain buffer is of very low capacitance and of very high impedance. Since the capacitive changes to be measured by the capacitive sensor are very small, i. e. in the range below $C \approx 10^{-12}$ Farad, just a few 10^{-12} Farad in parallel with the capacitance sensing means would make the measurement impossible. In addition, the resistance R of the resistor has to be very big (in the range of up to $R \approx 10^7$ Ohm) so as to result in a time constant of $\tau = C \cdot R \approx 10^{-12} \cdot 10^7 \text{ sec} = 10^{-5} \text{ sec}$ or a frequency of $f_{\text{out}} \approx 1/\tau \approx 10^5$ Hertz of the oscillator means. With the period time $T_{\text{out}} = 1/f_{\text{out}}$ of the oscillator means being about 10^{-5} sec and thus being relatively great compared with the duration time of an ESD transient (which is in the range of 10^{-9} sec), the disturbances of the output signal f_{out} caused by an ESD transient are extremely unlikely to produce detection errors.

In an advantageous embodiment of the present invention, the charging means are implemented by a trigger producing a high output signal $V_{2,\text{out}}$ at its output terminal if the input signal $V_{2,\text{in}}$ at its input terminal is below a certain lower threshold V_{low} . During this first half-period of the oscillation, current flows from the trigger output through the resistor and charges the capacitance sensing means. If the input signal $V_{2,\text{in}}$ at the input terminal of the trigger is beyond a certain upper threshold V_{up} the trigger produces a low output signal $V_{2,\text{out}}$ at its output terminal resulting in a current flow from the capacitance sensing means via the resistor to the output of the trigger. Consequently, the voltage over the capacitance sensing means decreases during this second half-period of the oscillation. This cycle repeats itself at the above-mentioned frequency $f_{\text{out}} \approx 1/(C \cdot R)$.

Preferably, the charging means are implemented by an inverting Schmitt-trigger, or by an operational amplifier with appropriate external components, or by a block comprising discrete transistors.

In a particularly advantageous embodiment of the present invention, the capacitive sensor comprises frequency detection means for measuring the frequency variation of the signal f_{out} of the oscillator means. This frequency detection means preferably comprises a frequency divider (with a divisor n of e.g. $2^{10} = 1024$), a reference oscillator, and a frequency comparator for comparing the divided frequency signal f_{out}/n of the oscillator means with the frequency signal f_{ref} of the reference oscillator. Since the reference oscillator can be trimmed, the provision of an ON / OFF output which is often used in capacitive proximity switches and which is dependent on a certain externally adjustable threshold point is possible. Needless to say, that dividing the frequency f_{out} by n has a desirable integrating effect, i. e. small erroneous variations of the period time $T_{\text{out}} = 1/f_{\text{out}}$ due to an ESD transient are levelled out.

Alternatively, the frequency detection means can also comprise a rectifier, a low-pass filter, a local oscillator, and a modulator for mixing the frequency signal f_{out} of the oscillator means with the frequency signal f_{loc} of the local oscillator which is for example tuned to zero-beat frequency. By mixing f_{out} and f_{loc} , a characteristic beat frequency f_{beat} is produced. The subsequent low-pass filter cuts off high frequencies beyond a certain threshold and lets pass through only the characteristic beat frequency f_{beat} as it is desired.

The present invention will be described in more detail below with reference to the exemplary embodiments which are schematically illustrated in the following drawings, in which:

Fig. 1 is a view of a circuit diagram showing an example of a capacitive sensor in accordance with the invention;

Fig. 2 is a magnified view in transversal section of the capacitance sensing means and of the guard means of a capacitive sensor according to the invention;

Fig. 3 is another magnified view in transversal section of the capacitance sensing means and of the guard means of a capacitive sensor according to the invention;

Fig. 4 is a view in transversal section of a printed circuit board of a capacitive sensor according to the invention;

Fig. 5 is a top view of the printed circuit board shown in Fig. 4;

Fig. 6 is another view in transversal section of a printed circuit board of a capacitive sensor according to the invention;

Fig. 7 is a schematic view of an embodiment of the frequency detection means;

Fig. 8 is a schematic view of another embodiment of the frequency detection means;

Fig. 9 is a circuit diagram of the charging means, here realized as an inverting Schmitt-trigger;

Fig. 10 is a diagram of the voltage curve of the inverting Schmitt-trigger shown in Fig. 9;

Fig. 11 is a diagram of the transfer characteristic of the inverting Schmitt-trigger shown in Fig. 9.

An example of realizing the capacitive sensor in accordance with the invention is illustrated in figure 1. This capacitive sensor can for example be implemented in an electric control circuit or in an electric regulator circuit in order to detect how close an object 6 has approached the capacitive sensor. This capacitive sensor can also be used to detect whether a physical quantity of a medium the capacitive sensor is sensitive for has reached a corresponding predetermined value. Needless to say, that the capacitive sensor can also be used to sense capacitive changes in many other applications as for example capacitive relative humidity sensors or capacitive membrane cells for pressure measurements. The basic principle of this capacitive sensor which will be explained in more detail below is as follows: as the capacity of the capacitance sensing means 1 changes with the approaching object 6 or the quantity to be measured, the frequency f_{out} of the output of this capacitive sensor changes with it.

The embodiment of a capacitive sensor according to the invention shown in figure 1 comprises the capacitance sensing means 1 and oscillator means 2 for detecting the presence of the object 6 placed at a variable distance in front of the capacitance sensing means 1. The oscillator means 2 is provided with a unity gain buffer 3 (where "unity" stands for an amplification factor of 1 of the gain buffer 3) for buffering the voltage over the capacitance sensing means 1 without imposing any load on the capacitance sensing means which consists in figure 1 of a conductive sensing plate 1 connected to the input terminal of the unity gain buffer 3. The output terminal of the unity gain buffer 3 is connected to the input terminal of charging means 4 for charging and discharging the capacitance sensing means 1 between some voltage levels (depending on the voltage applied to the input terminal of the charging means 4) via a resistor 5 which is connected to the capacitance sensing means 1 and to the output of the charging means 4 and which is very big (in the range of up to $R \approx 10^7$ Ohm). Frequency detection means not illustrated in figure 1 is connected in series to the oscillator means 2. Furthermore, it is not shown that positive supply is applied to the unity gain buffer 3 and/or the charging means 4.

Guard means 7 connected to the output of the unity gain buffer 3 and provided close to the capacitance sensing means 1 is symbolically shown in figure 1. Furthermore, a protective means 13 is placed between the capacitance sensing means 1 and the guard means 7 in order to avoid the negative effects of an ESD (electro static discharge) transient which appears when large static charges are induced on the outside of the housing of the capacitive sensor for example by plastic granulates passing the head of the capacitive sensor and / or rubbing the housing of the capacitive sensor. With these large static charges discharging to the capacitance sensing means 1, the resulting ESD transient would destroy the sensitive input of the unity gain buffer 3 of the oscillator means 2.

In figure 1, the protective means 13 comprises a pair of diodes 14, 15 directed in opposite ways. With the potential on both sides of these diodes 14, 15 being always the same, no potential is left across the protective means 13 and, consequently, no current flows through the diodes 14, 15 under normal operation. In case, that an ESD transient is

imposed on the capacitance sensing means 1, one of the diodes 14, 15 (depending on the polarity of the ESD transient) becomes conductive and leads the transient energy to the guard means 7. From the guard means 7, the transient energy is led to ground or to an additional terminal V_{DD} on a certain potential because capacitive load on the output of the unity gain buffer 3 has no effect on the capacitance sensing means 1.

Under normal operating conditions, the guard means 7 carries the same potential as the capacitance sensing means 1. This means that under normal operating conditions none of the diodes 14, 15 will ever be conductive and therefore the equivalent circuit for them would be a very small, negligible leakage current. The capacitive influence of such protective means 13 between the capacitance sensing means 1 and the guard means 7 is then cancelled out and no capacitive load is imposed on the capacitance sensing means 1. Thus, such protective means 13 can be used as a protection against electromagnetic interference as for instance electrostatic distortion.

Figure 2 shows a magnified view in transversal section of the guard means 7 as well as of the capacitance sensing means 1 of a capacitive sensor in accordance with the invention. An object 6, for example a solid or a liquid of any shape and volume, is placed between the capacitance sensing means which comprises two conductive sensing plates 1a, 1b in the embodiment illustrated in figure 2. The first conductive plate 1a is connected to ground and therefore carries vanishing potential, the other conductive plate 1b is connected with the input terminal of the unity gain buffer 3 (which is of very low capacitance and of very high impedance).

Figure 3 shows a magnified view in transversal section of the guard means 7 as well as of the capacitance sensing means 1 of another capacitive sensor in accordance with the invention. Like in figure 1, the capacitance sensing means is realized as a conductive sensing plate 1. Since the guard means 7 carries the same potential as the conductive sensing plate 1, the guard means 7 does not have any capacitive influence on the conductive sensing plate 1.

As it can be seen from figure 3, the guard means 7 is arranged laterally to and close behind the conductive sensing plate 1 to shield capacitive changes at the side or at the rear of the conductive sensing plate 1. Consequently, sensitivity just in front of the conductive sensing plate 1 is warranted, and all capacitive changes in the direction of the sides and / or of the rear of the conductive sensing plate 1 affect only this guard means 7. Thus, the electrostatic field which is exemplarily illustrated by five lines of electric flux spreading out from the conductive sensing plate 1 to the object 6 to be detected is confined to the region in front of the conductive sensing plate 1. All in all, the guard means 7 present an effective way of reducing the lateral and rear sensitivity of the conductive sensing plate 1 with respect to the influence from electronics and molding material inside the capacitive sensor.

The connection between the conductive sensing plate 1 and the input terminal of the unity gain buffer 3 (which is of very low capacitance and of very high impedance) is provided by a shielded cable 12 which is tightly connected to the guard means 7 in order to guarantee a shielding of the sensitive parts of the device without a gap. According to the embodiment shown in figure 3, the shielded cable 12 is attached to the central portion of the guard means 7.

Figures 4, 5 and figure 6 show two different embodiments of the printed circuit board 8 of the capacitive sensor according to the invention. With the capacitance sensing means 1 being preferably connected to the input of the unity gain buffer 3, this connection between the capacitance sensing means 1 and the input of the unity gain buffer 3 is provided by a line 9 on the printed circuit board 8. In figure 4, which shows a transversal section, as well as in figure 5, which is a top view, the guard means 7 is arranged as two lines 10a, 10b on the one side of the printed circuit board 8 and as one line 10c on the opposite side of the printed circuit board 8. In figure 6, which is a view also in transversal section of another printed circuit board 8 of a capacitive sensor according to the invention, the guard means 7 is arranged as two lines 10 on both sides of a multilayer printed circuit board 8 and as two lines 11a, 11b in an inner layer of the multilayer printed circuit board 8. Furthermore, the line 9 connecting the capacitance sensing means 1 and the input of the unity gain buffer 3 is embedded between the two lines 11a, 11b of the guard means 7 within the multilayer printed circuit board 8.

Figures 7 and 8 show two schematic views of the frequency detection means 16 arranged in series to the capacitance sensing means 1 and to the oscillator means 2. Generally, measuring the frequency of an alternating voltage is realized by comparing it with an exactly defined and calculable mechanical or electric resonance phenomenon. The most exact results for such frequency measurements can be obtained by beat-frequency meters which compare the frequency to be measured with a frequency standard. The latter can be defined by an atomic reference oscillator, by a quartz, crystal or piezoelectric reference oscillator, or by a synthesizer. At the best, this frequency standard is chosen in such way that the resulting difference frequency or beat frequency vanishes which can be indicated by a headset or by an instrument.

The frequency detection means 16 shown in figure 7 and designated for measuring the frequency variation of a signal f_{out} of the oscillator means 2 comprises a frequency divider 17, a reference oscillator 18, and a frequency comparator 19 for comparing the divided frequency signal f_{out}/n of the oscillator means 2 with the frequency signal f_{ref} of the reference oscillator 18. Since the reference oscillator 18 can be trimmed, the provision of an ON / OFF output which is often used in capacitive proximity switches and which is dependent on a certain externally adjustable threshold point is possible. In the example of figure 7, the output is ON in the case that the divided frequency signal f_{out}/n of the oscillator means 2 is smaller than the frequency signal f_{ref} of the reference oscillator 18. For the divided frequency signal f_{out}/n of the oscillator means 2 being greater than the frequency signal f_{ref} of the reference oscillator 18, the output is OFF.

Needless to say, that the frequency division of f_{out} by n has a desirable integrating effect, i. e. small erroneous variations of the single period time $T_{out} = 1 / f_{out}$ due to an ESD transient are levelled out.

The frequency detection means 16 shown in figure 8 and also designated for measuring the frequency variation of a signal f_{out} of the oscillator means 2 comprises a rectifier 23, a low-pass filter 22, a local oscillator 21, and a modulator 20. In the modulator 20, the frequency signal f_{out} is mixed and thus compared with the frequency standard f_{loc} produced by the local oscillator 21. The subsequent low-pass filter 22 cuts off the high frequencies beyond a certain threshold and lets pass through only the difference frequency f_{diff} or the beat frequency f_{beat} . After having passed the rectifier 23 the resulting signal is sent to a display instrument not shown in figure 8.

Figure 9 is a circuit diagram of the charging means, here realized as an inverting Schmitt-trigger 4. As it is illustrated by the diagram of its voltage curve in figure 10, this inverting Schmitt-trigger 4 produces a high output signal $V_{2,out}$ at its output terminal if the input signal $V_{2,in}$ at its input terminal is below a certain lower threshold V_{low} . During this first half-period of an oscillation, current flows from the output of the inverting Schmitt-trigger 4 through the resistor 5 and charges the capacitance sensing means 1. If the input signal $V_{2,in}$ at the input terminal of the inverting Schmitt-trigger 4 is beyond a certain upper threshold V_{up} the inverting Schmitt-trigger 4 produces a low output signal $V_{2,out}$ at its output terminal resulting in a current flow from the capacitance sensing means 1 via the resistor 5 to the output of the inverting Schmitt-trigger 4. Consequently, the voltage over the capacitance sensing means 1 decreases during this second half-period of the oscillation. This cycle repeats itself at the frequency $f_{out} \approx 1/(C \cdot R)$ where C is the capacity of the capacitance sensing means 1 and R is the resistance of the resistor 5.

The inverting Schmitt-trigger 4 of figure 9 comprises a comparator 4a as well as a voltage divider 4b, 4c consisting of a first resistor (resistance R_1) and of a second resistor (resistance R_2). Such a Schmitt-trigger 4 offers as a special feature that its turn-on-level $V_{low} = V_{2,out}^{min} \cdot R_2 / (R_1 + R_2)$ does not coincide with its turn-off-level $V_{up} = V_{2,out}^{max} \cdot R_2 / (R_1 + R_2)$ but the two differ by a switching backlash $\Delta V_{sb} = (V_{2,out}^{max} - V_{2,out}^{min}) \cdot R_2 / (R_1 + R_2)$ (for an illustration of V_{low} and V_{up} as well as of $V_{2,out}^{min}$ and $V_{2,out}^{max}$ confer to the diagram of the voltage curve of the inverting Schmitt-trigger 4 in figure 10 as well as to the transfer characteristic of the inverting Schmitt-trigger 4 in figure 11). In the inverting Schmitt-trigger 4 such as shown in figure 9, this switching backlash ΔV_{sb} is produced by a so-called regenerative feedback of the comparator 4a via the voltage divider 4b, 4c. For a great negative voltage $V_{2,in}$ at the input terminal of the inverting Schmitt-trigger 4, $V_{2,out}$ at its output terminal reaches the maximum value $V_{2,out}^{max}$. In this case, the maximum potential V_{up} at the P-input terminal of the comparator 4a of the inverting Schmitt-trigger 4 is therefore given by $V_{up} = V_{2,out}^{max} \cdot R_2 / (R_1 + R_2)$. With increasing voltage $V_{2,in}(t)$ at the input terminal of the inverting Schmitt-trigger 4, the voltage $V_{2,out}(t)$ at its output terminal is not changed during the first half-period of the oscillation. But with the voltage $V_{2,in}(t)$ at the input terminal of the inverting Schmitt-trigger 4 reaching the value V_{up} , the voltage $V_{2,out}(t)$ at its output terminal abruptly and rapidly decreases to the value $V_{2,out}^{min}$ because of regenerative feedback: the decrease of the voltage $V_{2,out}(t)$ at the output terminal of the inverting Schmitt-trigger 4 implies the decrease of the voltage at the P-input terminal of the comparator 4a of the inverting Schmitt-trigger 4, i. e. the difference value of the voltage at the P-input terminal minus the voltage at the N-input terminal becomes negative which forms a regenerative feedback. As a result, the potential at the P-input terminal of the comparator 4a of the inverting Schmitt-trigger 4 reaches its minimum value $V_{low} = V_{2,out}^{min} \cdot R_2 / (R_1 + R_2)$. Now, the difference value of the voltage at the P-input terminal minus the voltage at the N-input terminal becomes very negative, and the state of the inverting Schmitt-trigger 4 is stable during this second half-period of the oscillation as long as the voltage $V_{2,in}(t)$ at the input terminal of the inverting Schmitt-trigger 4 has not yet reached the value V_{low} . If the latter is the case, the voltage $V_{2,out}(t)$ at the output terminal of the inverting Schmitt-trigger 4 abruptly and rapidly increases to the value $V_{2,out}^{max}$ which forms the end of the second half-period of the oscillation.

The mode of operation of the inverting Schmitt-trigger 4 which has been explained above is additionally illustrated by the diagram of its voltage curve in figure 10 as well as by its transfer characteristic in figure 11.

Claims

1. A capacitive sensor comprising capacitance sensing means (1) and oscillator means (2), for measuring capacitive changes, characterized in that the oscillator means (2) comprises a unity gain buffer (3) for buffering the voltage over the capacitance sensing means (1) without imposing any load on the latter, the output terminal of the unity gain buffer (3) being connected to the input terminal of charging means (4) for charging and discharging the capacitance sensing means (1) via a resistor (5) which is connected to the capacitance sensing means (1) and to the output of the charging means (4).
2. A capacitive sensor according to claim 1, characterized in that the capacitance sensing means comprises at least one conductive sensing plate (1) arranged to detect the presence of an object (6) placed at a variable distance.

3. A capacitive sensor according to claim 1 or 2, characterized by the provision of guard means (7) arranged to at least partially surround the capacitance sensing means (1) to shield the capacitance sensing means (1) from capacitive changes caused by interferential action.
- 5 4. A capacitive sensor according to any of the claims 1 to 3, characterized in that the capacitance sensing means (1) is connected to the input of the unity gain buffer (3).
5. A capacitive sensor according to claim 4, characterized in that the connection between the capacitance sensing means (1) and the input of the unity gain buffer (3) is provided by a line (9) on a printed circuit board (8).
- 10 6. A capacitive sensor according to claim 3 and 5, characterized in that the guard means (7) is arranged as at least one line (10) on at least one side and / or on the opposite side of the printed circuit board (8).
7. A capacitive sensor according to claim 3 and 5, characterized in that the guard means (7) is arranged as at least one line (11) in an inner layer of a multilayer printed circuit board (8).
- 15 8. A capacitive sensor according to claim 4, characterized in that the connection between the capacitance sensing means (1) and the input of the unity gain buffer (3) is provided by a shielded cable (12).
- 20 9. A capacitive sensor according to claim 3 and 8, characterized in that the shielded cable (12) is tightly connected to the guard means (7).
10. A capacitive sensor according to claim 3 and 9, characterized in that the shielded cable (12) is attached to the central portion of the guard means (7).
- 25 11. A capacitive sensor according to claim 3, characterized in that the guard means (7) is connected to the output of the unity gain buffer (3).
12. A capacitive sensor according to claim 3, characterized in that the guard means (7) carries the same potential as the capacitance sensing means (1).
- 30 13. A capacitive sensor according to claim 3, characterized in that a protective means (13) is placed between the capacitance sensing means (1) and the guard means (7).
- 35 14. A capacitive sensor according to claim 13, characterized in that the protective means (13) comprises a pair of diodes (14, 15) directed in opposite ways.
15. A capacitive sensor according to any of the claims 1 to 14, characterized in that the input terminal of the unity gain buffer (3) is of very low capacitance and of very high impedance.
- 40 16. A capacitive sensor according to any of the claims 1 to 15, characterized in that the charging means are implemented by a trigger (4) producing a high output signal $V_{2,out}$ at its output terminal if the input signal $V_{2,in}$ at its input terminal is below a certain lower threshold V_{low} , and producing a low output signal $V_{2,out}$ at its output terminal if the input signal $V_{2,in}$ at its input terminal is beyond a certain upper threshold V_{up} .
- 45 17. A capacitive sensor according to claim 16, characterized in that the charging means (4) are implemented by an inverting Schmitt-trigger, or by an operational amplifier with appropriate external components, or by a block comprising discrete transistors.
- 50 18. A capacitive sensor according to any of the claims 1 to 17, characterized in that the capacitive sensor comprises frequency detection means (16) for measuring the frequency variation of a signal f_{out} of the oscillator means (2).
19. A capacitive sensor according to claim 18, characterized in that the frequency detection means (16) comprises a frequency divider (17), a reference oscillator (18), and a frequency comparator (19) for comparing the divided frequency signal f_{out}/n of the oscillator means (2) with the frequency signal f_{ref} of the reference oscillator (18).
- 55 20. A capacitive sensor according to claim 18, characterized in that the frequency detection means (16) comprises a rectifier (23), a low-pass filter (22), a local oscillator (21), and a modulator (20) for mixing the frequency signal f_{out} of the oscillator means (2) with the frequency signal f_{loc} of the local oscillator (21).

Fig.1

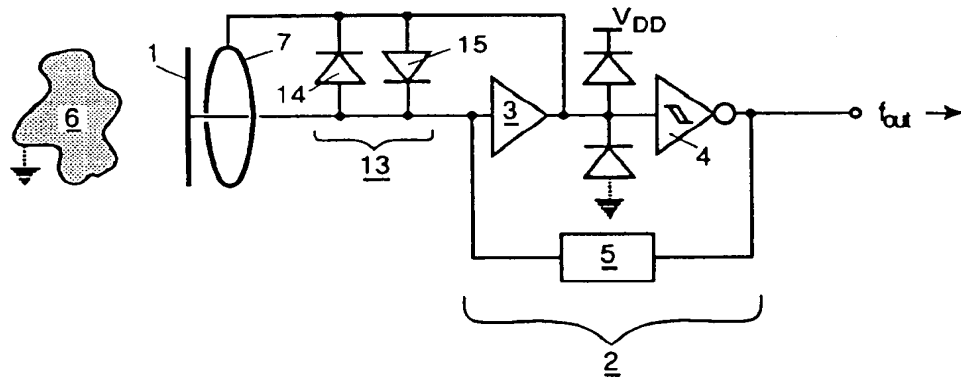


Fig.2

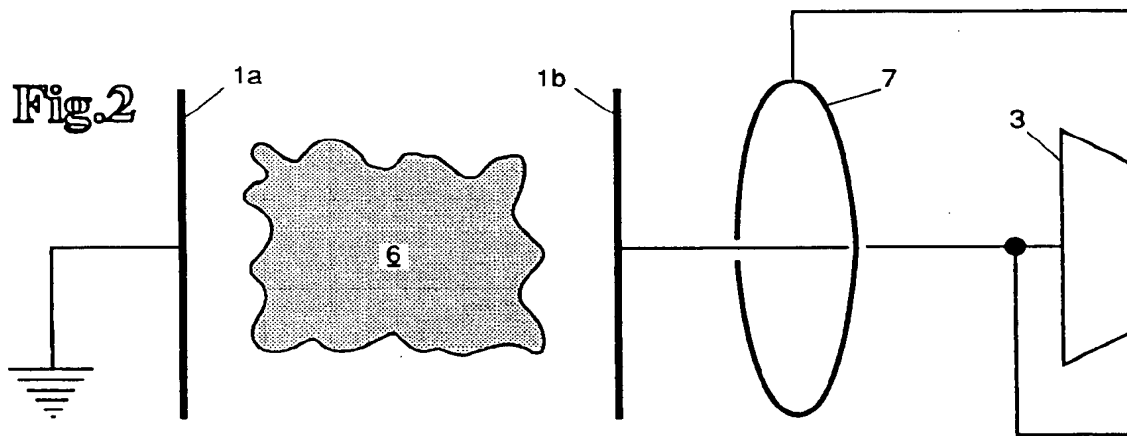


Fig.3

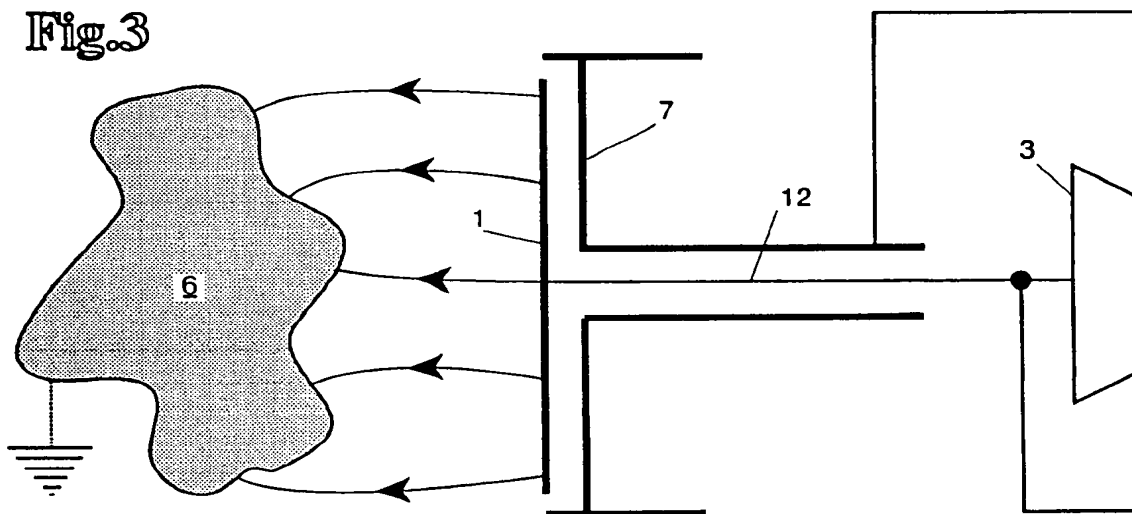


Fig.4

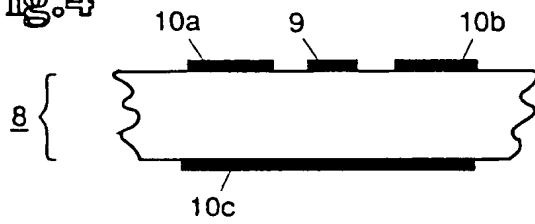


Fig.5

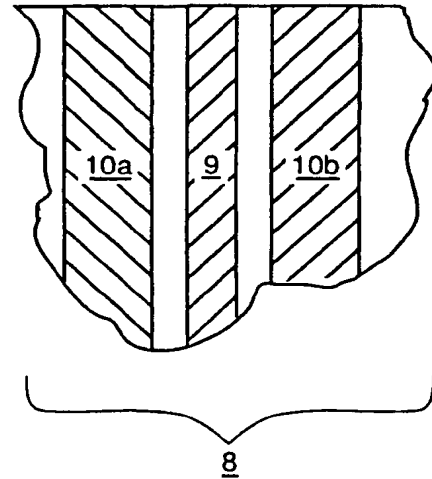


Fig.6

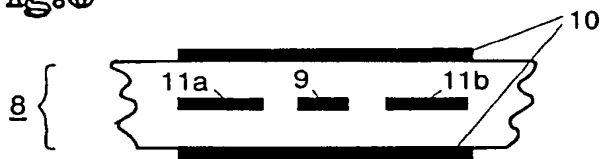


Fig.7

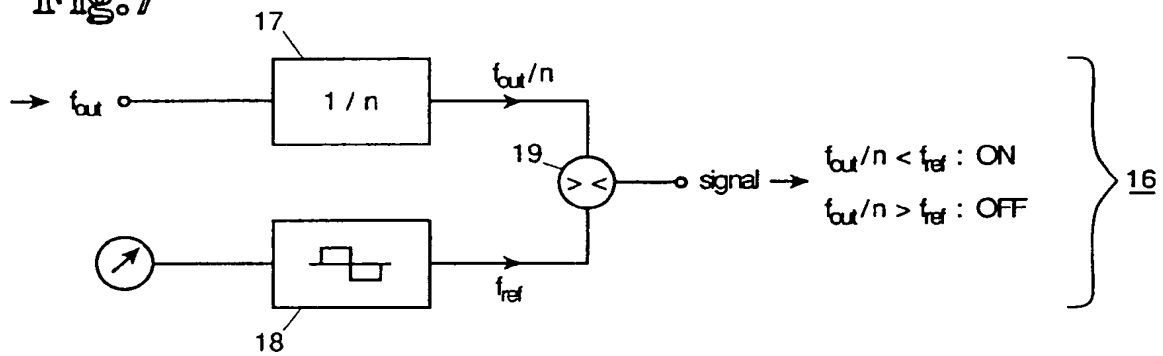


Fig.8

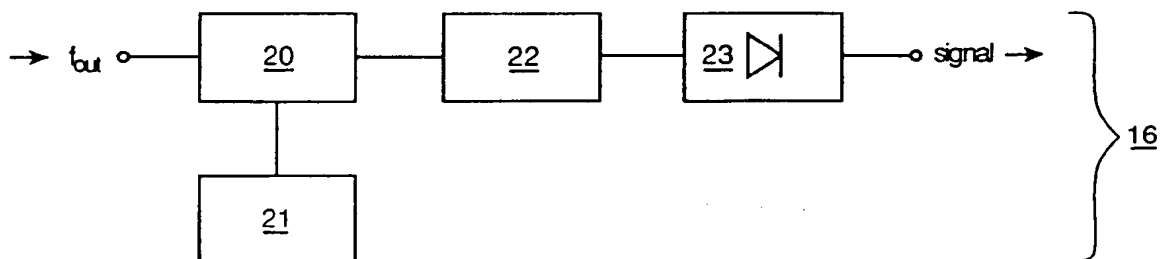


Fig.9

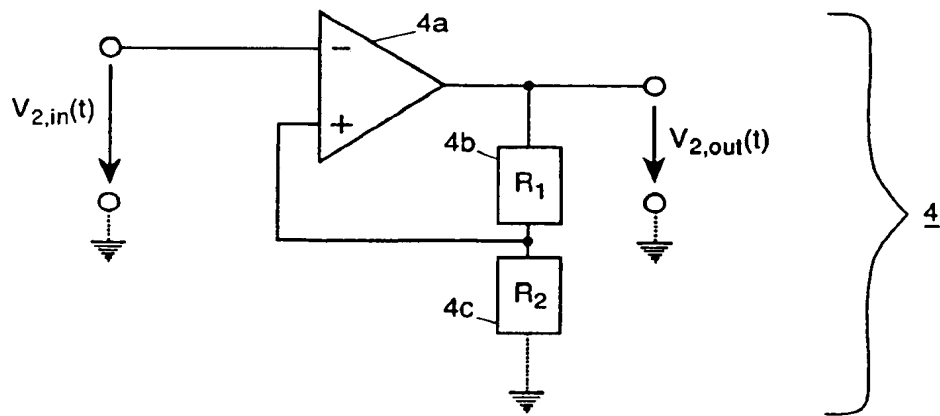


Fig.10

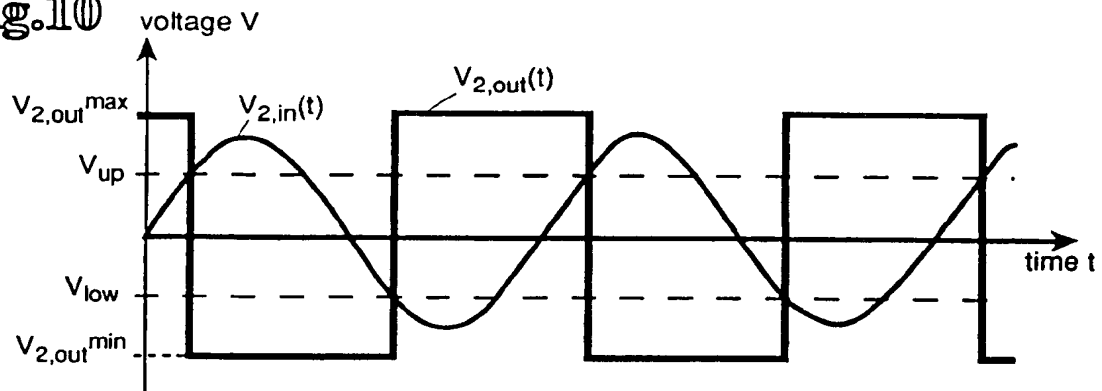
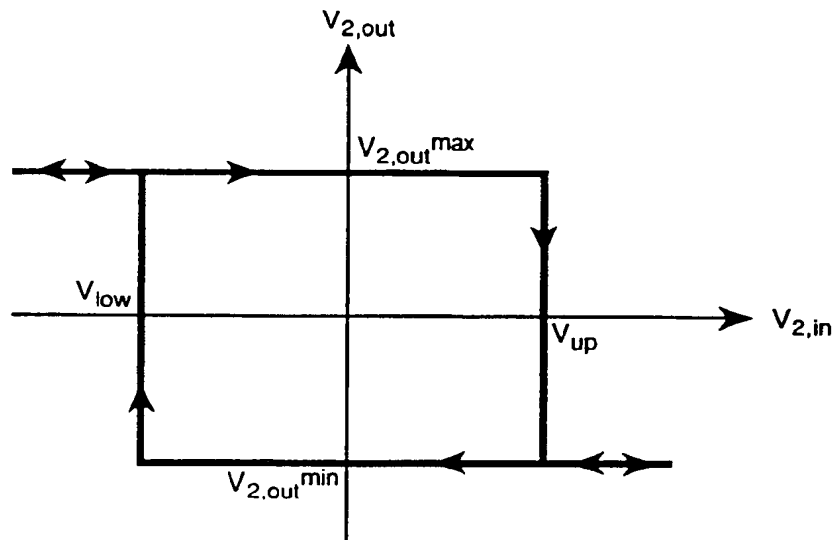


Fig.11





European Patent
Office

EUROPEAN SEARCH REPORT

Application Number
EP 95 10 0627

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.6)
X	WO-A-90 14604 (MOONSTONE DESIGNS LTD) 29 November 1990	1-5, 11, 12, 16-18, 19, 20	G01V3/08 H03K17/955
Y	* page 2, line 14 - page 3, line 20 * * page 5, line 8 - page 6, line 14 * * page 10, line 13 - line 17 * * figure 1 *		
A	FR-A-2 271 538 (CII) 12 December 1975 * page 2, line 5 - line 21; figure 1 *	8-10	
A	GB-A-1 515 431 (GTE INTERNATIONAL INC) 21 June 1978 * page 1, right column, line 50 - line 55; figure *	13, 14	
Y	DE-A-31 25 925 (KOHLER HANS MICHAEL) 10 March 1983 * page 7, line 22 - page 8, line 17 * * figure 1 *	19	
Y	DONALD G. FINK ET AL. 'Electronics Engineers' Handbook' 1983, MCGRAW-HILL, US NEW YORK * page 17-36, paragraph 100 * * page 17-37; figures 17-61 *	20	TECHNICAL FIELDS SEARCHED (Int.Cl.6) G01V H03K
The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 12 June 1995	Examiner D/L PINTA BALLE., L
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document		T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document	

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